

ZSM560

ABSOLUTE MAXIMUM RATING

Input Supply Voltage	-1 to 10V	Power Dissipation	
Offstate Output Voltage	10V	TO92	780mW
Onstate Output		SOT223	2W(Note 2)
Sink Current(Note 1)	Internally limited		
Clamp Diode			
Forward Current(Note 1)	100mA		
Operating Junction Temperature	150°C		
Operating Temperature	-40 to 85°C		
Storage Temperature	-55 to 150°C		

TEST CONDITIONS

($T_{amb}=25^{\circ}\text{C}$ for typical values, $T_{amb}=-40$ to 85°C for min/max values (Note3))

COMPARATOR

PARAMETER	SYMBOL	MIN	TYP.	MAX.	UNITS
Threshold Voltage High state output (V_{cc} increasing)	V_{IH}	4.5	4.61	4.7	V
Threshold Voltage Low state output (V_{cc} decreasing)	V_{IL}	4.5	4.59	4.7	V
Hysteresis	V_H	0.01	0.02	0.05	V

OUTPUT

Output sink saturation: ($V_{cc}=4.0\text{V}$, $I_{sink}=8.0\text{mA}$) ($V_{cc}=4.0\text{V}$, $I_{sink}=2.0\text{mA}$) ($V_{cc}=1.0\text{V}$, $I_{sink}=0.1\text{mA}$)	V_{OL}		0.46 0.15	1.0 0.4 0.25	V V V
Onstate output sink current (V_{cc} , Output=4V)	I_{sink}	10	20	60	mA
Offstate output leakage current (V_{cc} , Output=5V)	I_{oh}		0.02	0.5	μA
Clamp diode forward voltage ($I_f=10\text{mA}$)	V_f	0.6	1.2	1.5	V
Propagation delay (V_{in} 5V to 4V, $R_f=10\text{k}$, $T_{amb}=25^{\circ}\text{C}$)	T_d		1.5		μs

TOTAL DEVICE

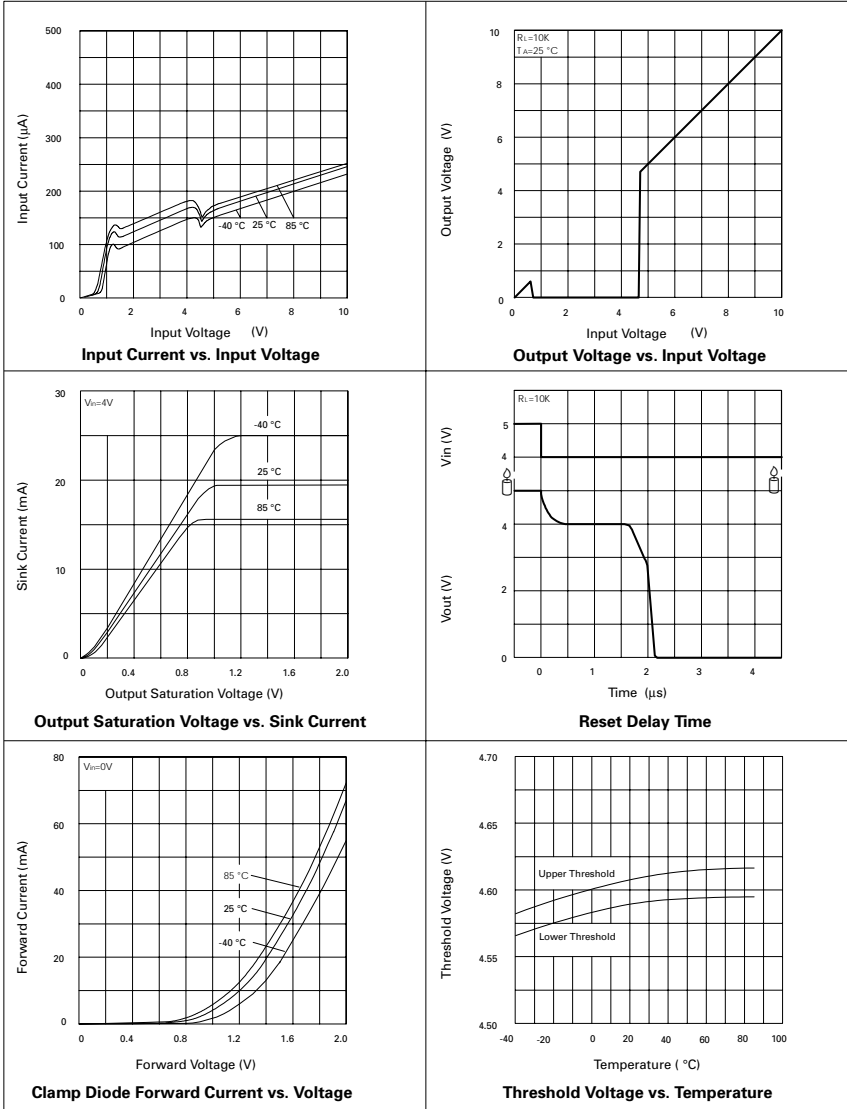
Operating input voltage range	V_{cc}	1.0 to 6.5			V
Quiescent input current ($V_{cc}=5\text{V}$)	I_q		135	200	μA

Note:

1. Maximum package power dissipation must be observed.
2. Maximum power dissipation for the SOT223 package is calculated assuming that the device is mounted on a PCB measuring 2 inches square.
3. Low duty cycle pulse techniques are used during test to maintain junction temperatures as close to ambient as possible.

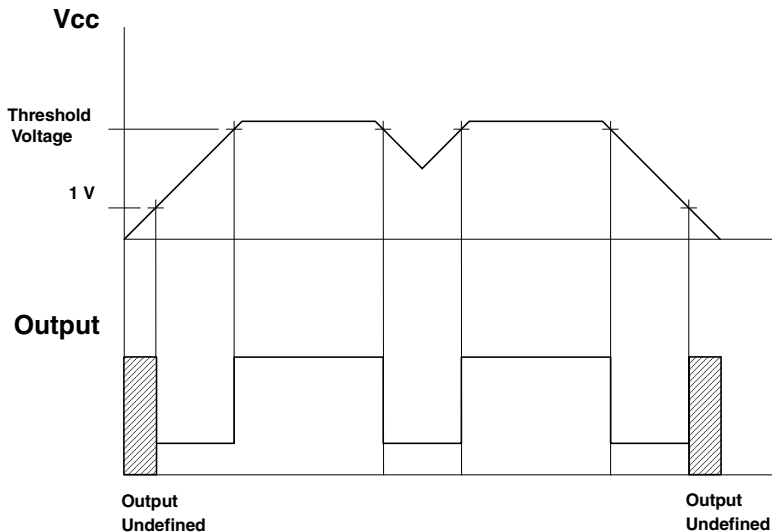
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TYPICAL CHARACTERISTICS

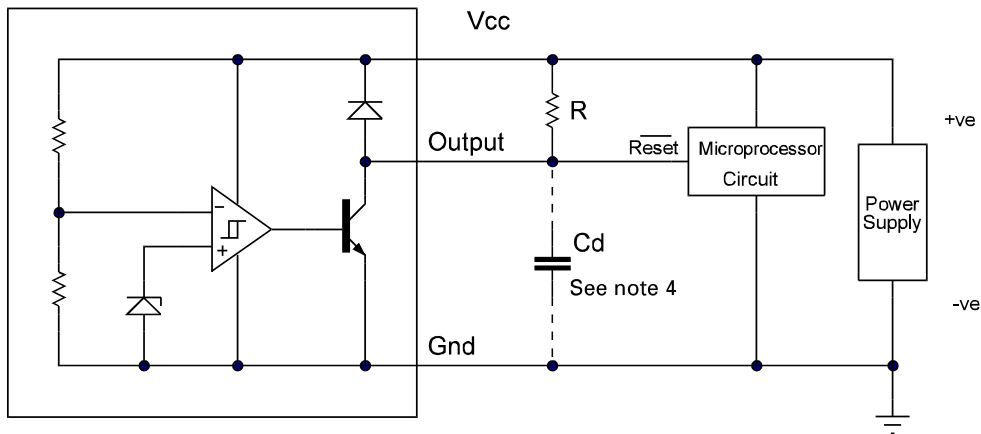


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TIMING DIAGRAM



APPLICATION CIRCUIT



Note 4: A time delayed reset can be accomplished with the additional Cd.

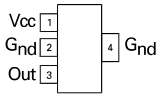
$$T_{DY} = RCd \ln \left(\frac{1}{1 - \frac{V_{TH}(mpu)}{V_{in}}} \right)$$

T_{DY} = Time (Seconds)
 V_{TH} = Microprocessor Reset Threshold
 V_{in} = Power Supply Voltage

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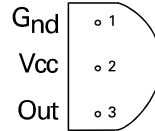
CONNECTION DIAGRAMS

SOT223 Package Suffix – G



*Top View –
Pin 4 floating or connected to pin 2*

TO92 Package Suffix – C



Bottom View

ORDERING INFORMATION

Part Number	Package	Part Mark
ZSM560G	SOT223	ZSM560
ZSM560C	TO92	ZSM560

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